1-826469-3 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 1-826469-3 PCB Mount Header, Vertical, Board-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 26

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	26
Number of Rows	2
Board-to-Board Configuration	Parallel
Body Features	
Connector Profile	Standard
Primary Product Color	Black
Contact Features	
PCB Contact Termination Area Plating Material Thickness	3 – 5 µm
Contact Shape & Form	Round
Contact Underplating Material	Nickel

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PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Zinc	
Contact Mating Area Plating Material	Gold	
Contact Type	Pin	
Contact Current Rating (Max)	5 A	
Termination Features		
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	With	
Mating Alignment Type	Polarization	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
PCB Mount Alignment Connector Mounting Type	Without Board Mount	
Connector Mounting Type		

Dimensions

Row-to-Row Spacing	2.54 mm[.1 in]	
PCB Thickness (Recommended)	1.57 mm[.062 in]	
Usage Conditions		
Housing Temperature Rating	High	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Type	Box	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	

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EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Pin-in-Paste capable to 260°C	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts

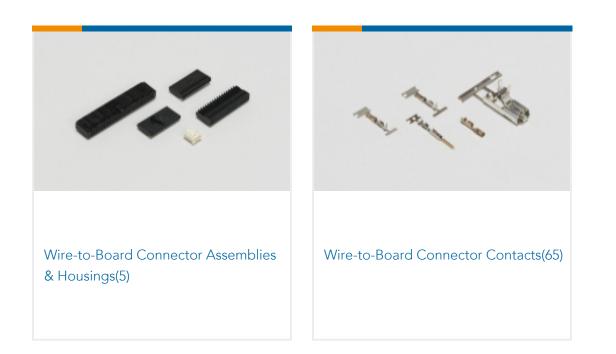


Also in the Series AMPMODU Headers



PCB Mount Header, Vertical, Board-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers





Customers Also Bought



2X3P MOD II SHROUDED HEADER, ST	JPT REC 2.8 Contact SRC Sn (LP)	SMCB 12 F AB VV 7-03 CL * H007 137 E002	SMCB 12 M AB VV 7-03 CL * 0007 137 E004
TE Part #254262-E SMCQ 12 F AB VV 7-03 CL * 0007 137 E002	TE Part #384275-E STVB/3 20 M AB VV 4-00 0606 * * 247 E007		

Documents

Product Drawings 2X13P MOD II SHROUDED HEADER, ST

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-826469-3_E.2d_dxf.zip

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English

Customer View Model ENG_CVM_CVM_1-826469-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-826469-3_E.3d_stp.zip

English

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Agency Approvals UL Report

English